

TIF700Q Series thermally conductive interface materials are applied to fill the air gaps between the heating elements and the heat dissipation fins or the metal base. Their flexibility and elasticity make them suited to coat very uneven surfaces. Heat can transmit to the metal housing or dissipation plate from the heating elements or even the entire PCB, which effectively enhances the efficiency and life-time of the heat-generating electronic components.

Typical Properties of TIF700Q Series

Color	Gray	Visual
Construction	Ceramic filled silicone elastomer	*****
Thickness range	1.0mm to 10.0mm	ASTM D374
Hardness	60 Shore 00	ASTM D2240
Specific Gravity	3.48g/cc	ASTM D297
Operating Temp	-40 ~160 °C	*****
Dielectric Breakdown Voltage	5.5 KV	ASTM D149
Dielectric Constant@1MHz	4.5 MHz	ASTM D150
Volume Resistivity	5.2X10 ¹³ Ohm-meter	ASTM D257
Thermal Conductivity	8.0 W/mK	ASTM D5470
	8.0 W/mK	GB-T32064
Outgassing (TML)	0.30%	ASTM E595
Flame Rating	UL94 V0	UL E331100

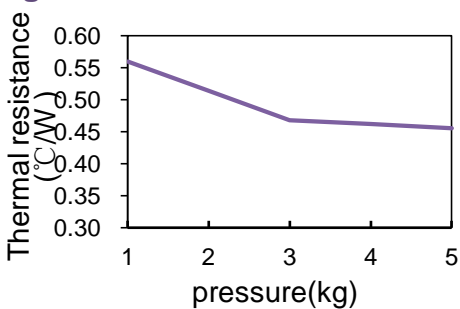
Features

- » Good thermal conductivity: 8.0 W/mK
- » Naturally tacky needing no further adhesive coating
- » Soft and Compressible for low stress applications
- » Available in varies thickness

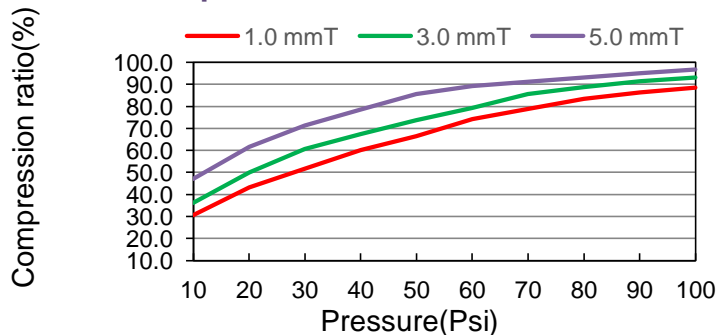
Application

- » Cooling components to the chassis of frame
- » Set Top Box
- » Car Battery & Power Supply
- » Charging Pile
- » LED TV/ Lighting
- » Graphics Card Thermal Module

kg. vs. Thermal Resistance



Psi. vs. Compression Ratio



Product Specification

Product Thicknesses

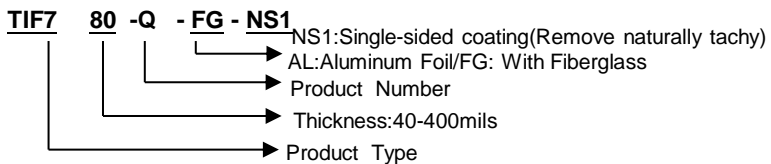
0.040-inch to 0.400-inch (10.0mm to 10.0mm)

Product Sizes

10" x 16" (254mm x 406mm)

Individual die cut shapes and custom thickness can be supplied. Please contact us for confirming.

Product Identification:



Thermally Conductive Materials Heat Generating Materials Thermally Conductive Plastics
 Foaming Silica Gel Die-Cutting Products

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